

FIG. 1A

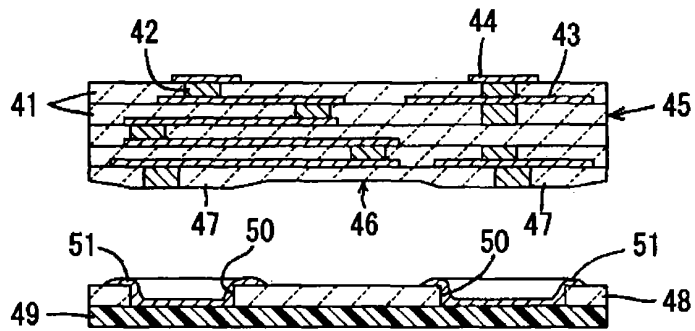


FIG. 1B

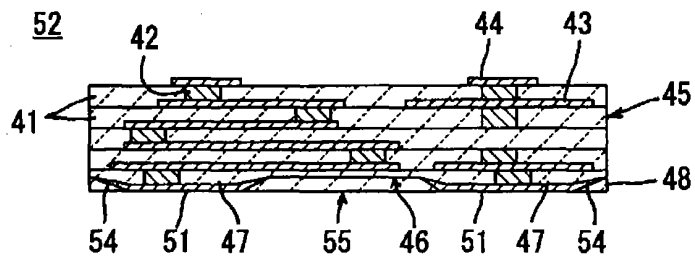


FIG. 1C

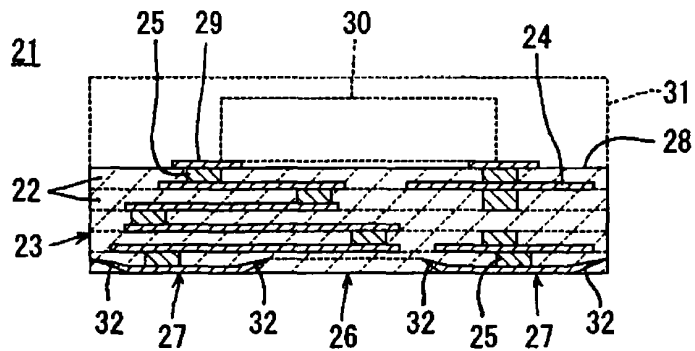


FIG. 1D

FIG. 2

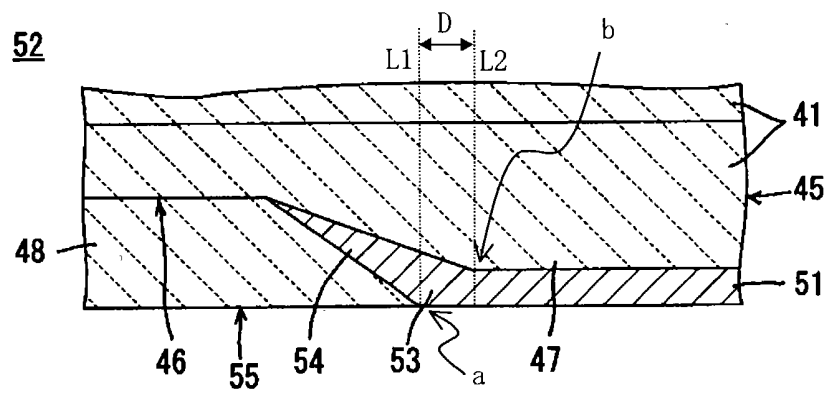


Fig. 52

A cross-sectional view of a device. It shows a substrate 41 with a layer 45 and a patterned layer 51. A curved layer 48 is shown above 51, with a dashed line 56 indicating its profile. Arrows indicate forces T1 and T2 applied to the layers.

FIG. 4

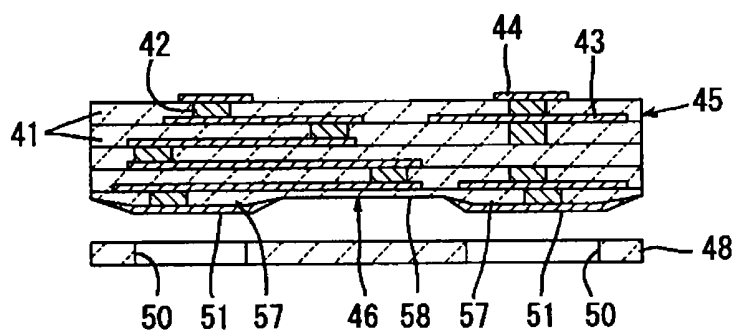


FIG. 5

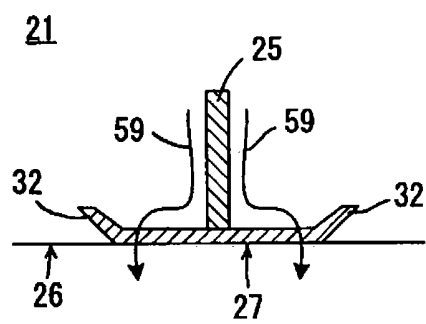


FIG. 6

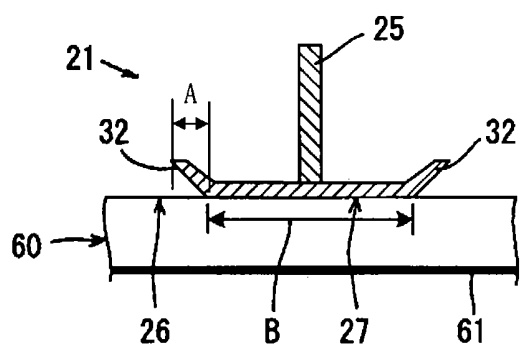


FIG. 7

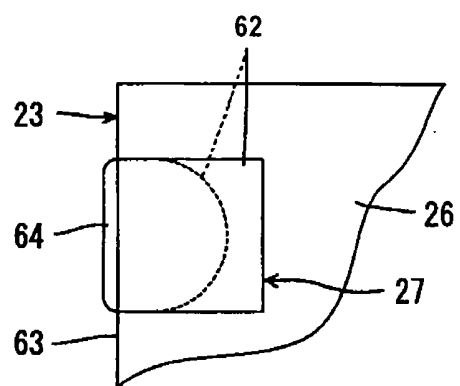


FIG. 8

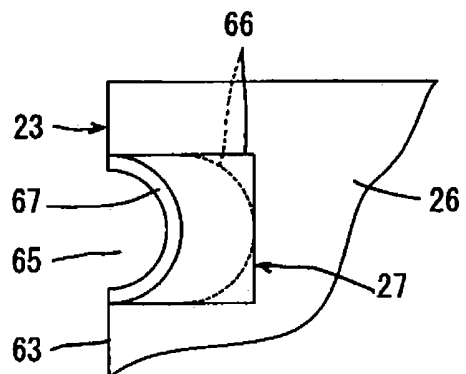


FIG. 9
PRIOR ART

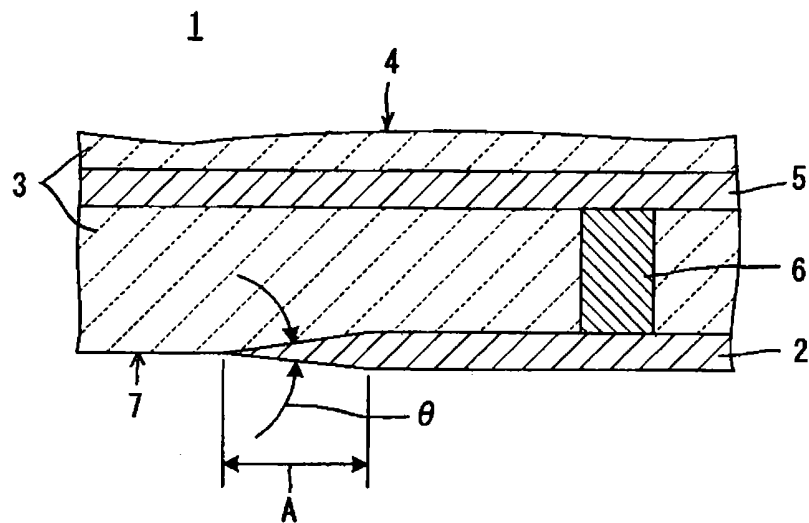


FIG. 10

PRIOR ART

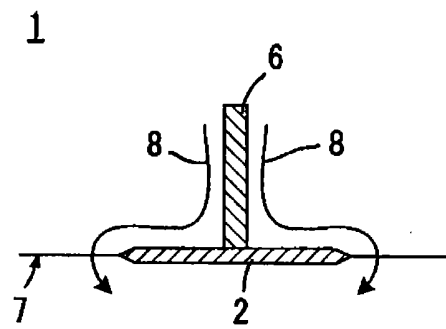


FIG. 11

PRIOR ART

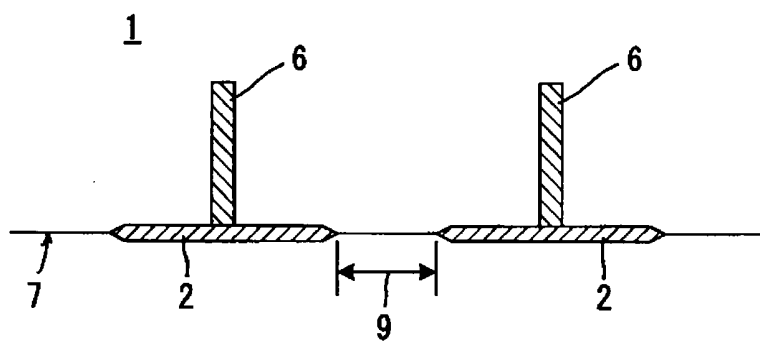


FIG. 12

PRIOR ART

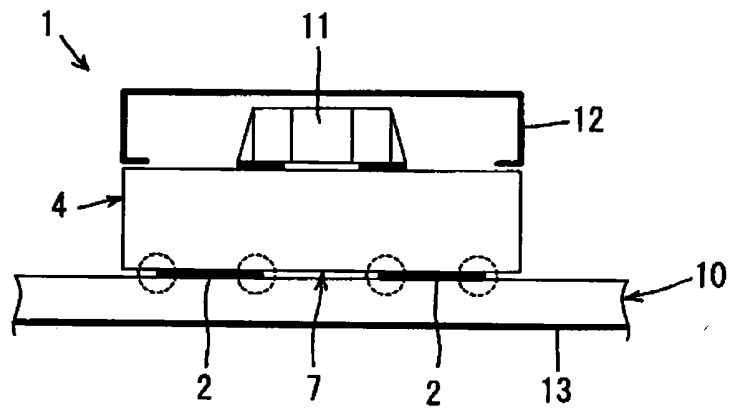


FIG. 13

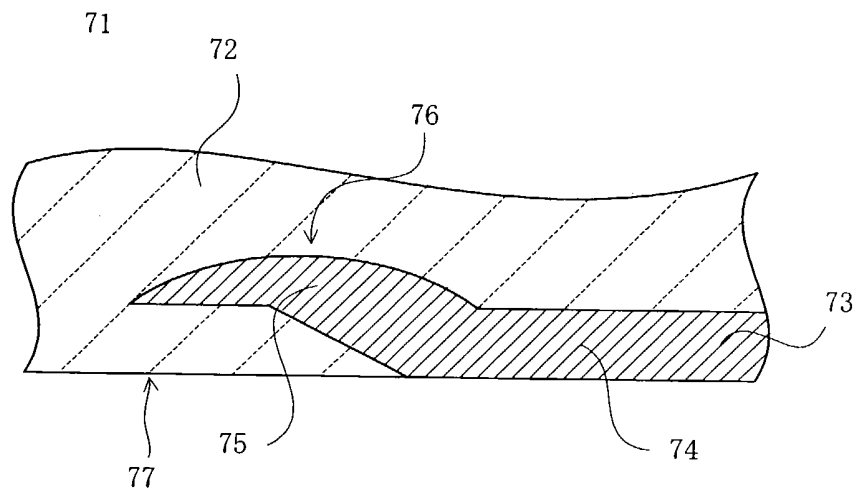


FIG. 14

